

- ◆ N-Channel Power MOS FET
- ◆ DMOS Structure
- ◆ Low On-State Resistance: 0.18Ω MAX
- ◆ Ultra High-Speed Switching
- ◆ SOT-89 Package

■ Applications

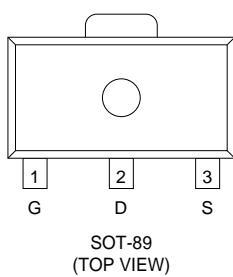
- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■ General Description

The XP161A01A8PR is a N-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOT-89 package makes high density mounting possible.

■ Features

- Low on-state resistance:** $R_{ds(on)}=0.11\Omega(V_{gs}=10V)$
 $R_{ds(on)}=0.18\Omega(V_{gs}=4.5V)$
- Ultra high-speed switching**
- Operational Voltage:** 4.5V
- High density mounting:** SOT-89

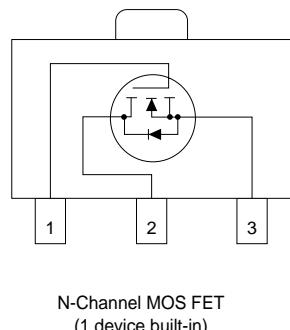


■ Pin Configuration

■ Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	D	Drain
3	S	Source

■ Equivalent Circuit



■ Absolute Maximum Ratings

Ta=25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	30	V
Gate-Source Voltage	Vgss	± 20	V
Drain Current (DC)	Id	3	A
Drain Current (Pulse)	Idp	9	A
Reverse Drain Current	ldr	3	A
Continuous Channel Power Dissipation (note)	Pd	2	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55~150	°C

Note: When implemented on a glass epoxy PCB

■ Electrical Characteristics

DC characteristics

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	I _{dss}	V _{ds} =30V, V _{gs} =0V			10	µA
Gate-Source Leakage Current	I _{gss}	V _{gs} =±20V, V _{ds} =0V			±10	µA
Gate-Source Cut-off Voltage	V _{gs(off)}	I _d =1mA, V _{ds} =10V	1.0			V
Drain-Source On-state Resistance (note)	R _{ds(on)}	I _d =1.5A, V _{gs} =10V		0.08	0.11	Ω
		I _d =1.5A, V _{gs} =4.5V		0.14	0.18	Ω
Forward Transfer Admittance (note)	Y _{fs}	I _d =1.5A, V _{ds} =10V		3.5		S
Body Drain Diode Forward Voltage	V _f	I _f =3A, V _{gs} =0V		0.85	1.1	V

Note: Effective during pulse test.

Dynamic characteristics

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	C _{iss}	V _{ds} =10V, V _{gs} =0V f=1MHz		220		pF
Output Capacitance	C _{oss}			140		pF
Feedback Capacitance	C _{rss}			55		pF

Switching characteristics

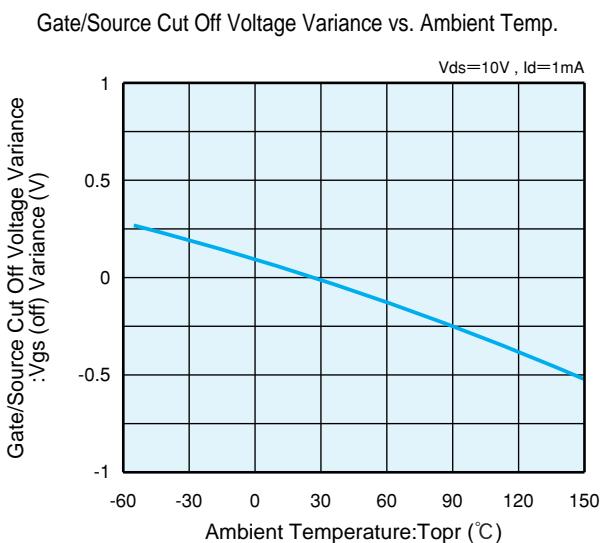
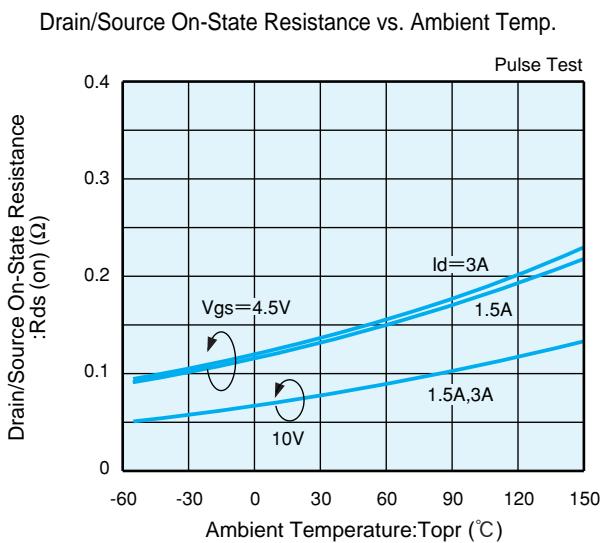
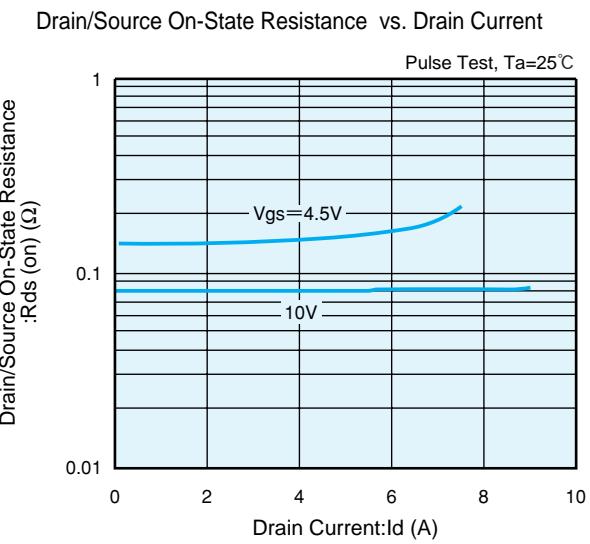
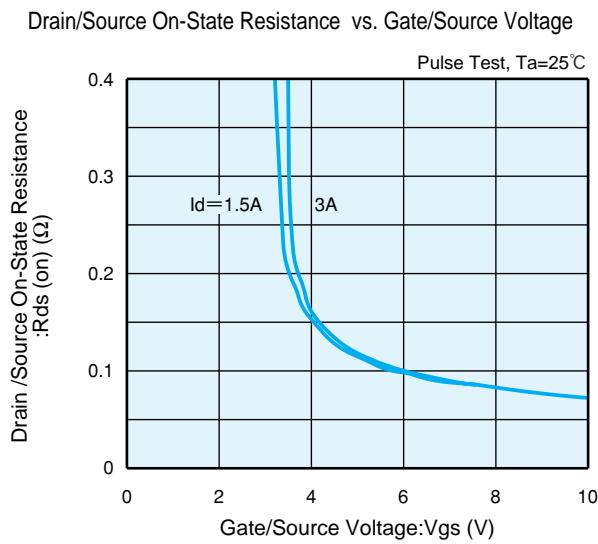
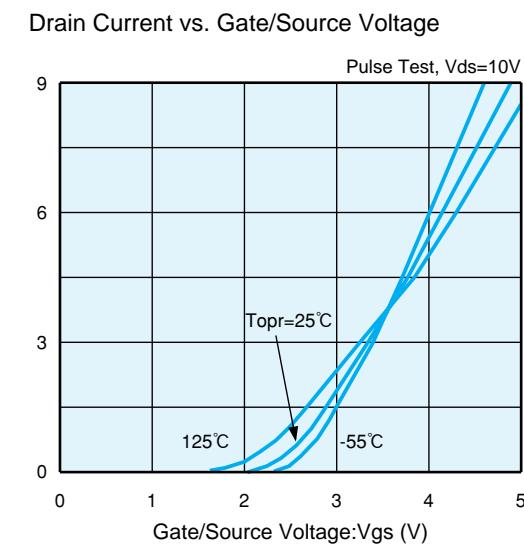
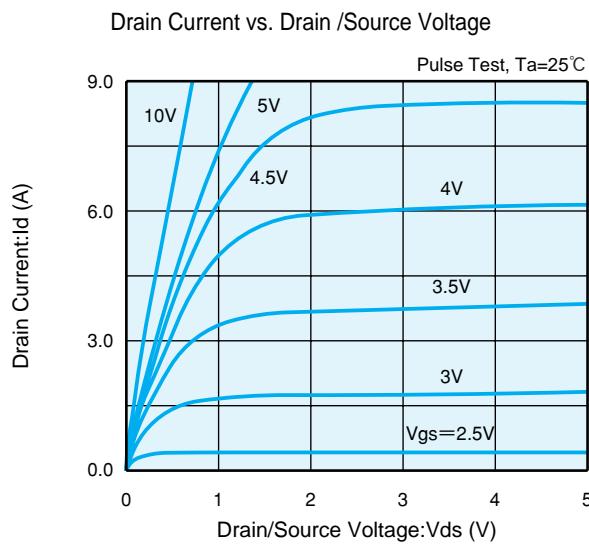
T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	t _d (on)	V _{gs} =5V, I _d =1.5A V _{dd} =10V		15		ns
Rise Time	t _r			15		ns
Turn-off Delay Time	t _d (off)			25		ns
Fall Time	t _f			15		ns

Thermal characteristics

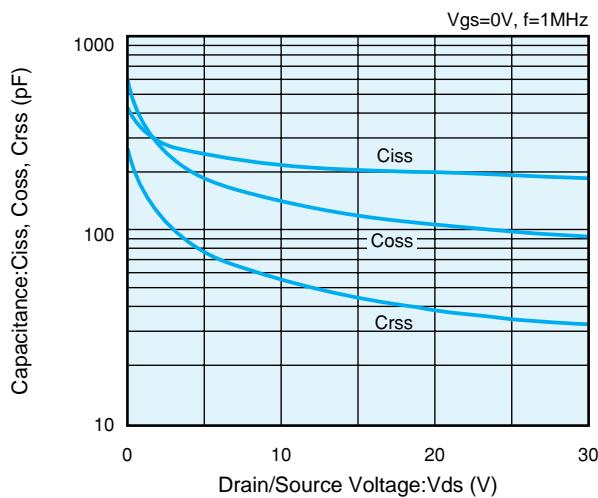
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance (channel-surroundings)	R _{th} (ch-a)	Implement on a glass epoxy resin PCB		62.5		°C/W

■ Electrical Characteristics

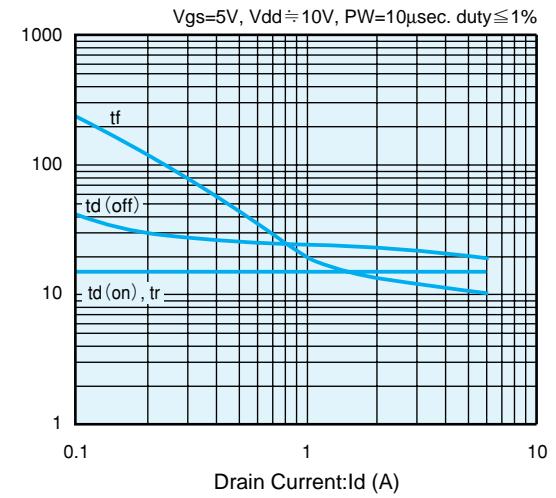


■ Electrical Characteristics

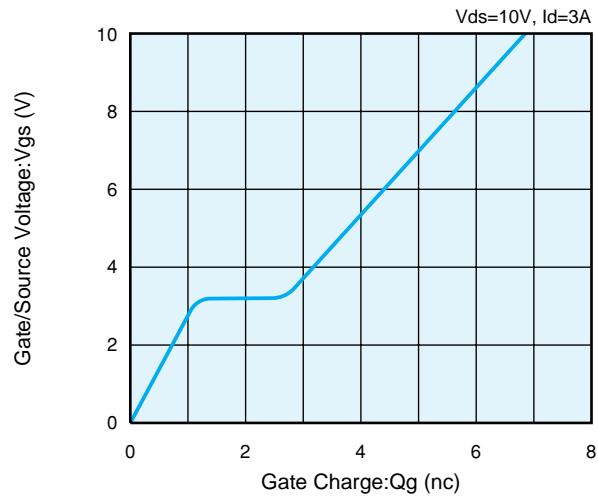
Drain/Source Voltage vs. Capacitance



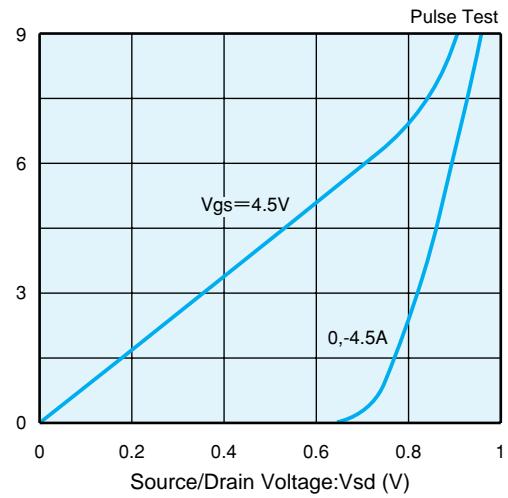
Switching Time vs. Drain Current



Gate/Source Voltage vs. Gate Charge



Reverse Drain Current vs. Source/Drain Voltage



Standardized Transition Thermal Resistance vs. Pulse Width

